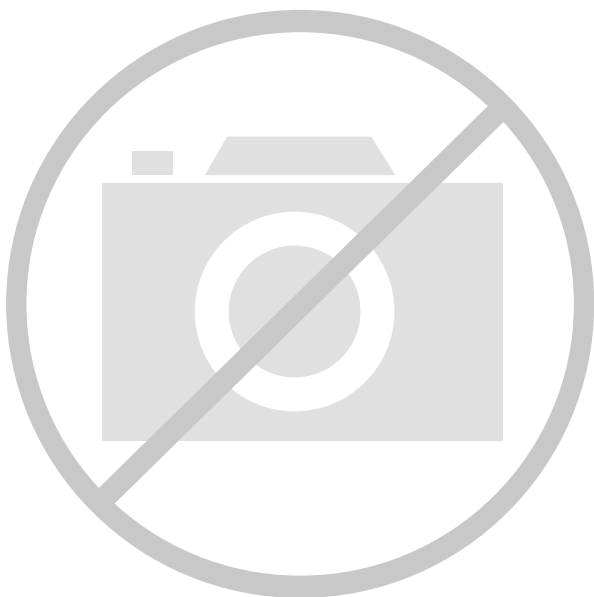




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	942
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1704-BCBGA, FCBGA
Supplier Device Package	1704-CFCBGA (42.5x42.5)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga115ep1-6fc1704c

Features

■ High Performance FPGA Fabric

- 15K to 115K four input Look-up Tables (LUT4s)
- 139 to 942 I/Os
- 700MHz global clock; 1GHz edge clocks

■ 4 to 32 High Speed SERDES and flexiPCS™ (per Device)

- Performance ranging from 600Mbps to 3.8Gbps
- Excellent Rx jitter tolerance (0.8UI at 3.125Gbps)
- Low Tx jitter (0.25UI typical at 3.125Gbps)
- Built-in Pre-emphasis and equalization
- Low power (typically 105mW per channel)
- Embedded Physical Coding Sublayer (PCS) provides pre-engineered implementation for the following standards:
 - GbE, XAUI, PCI Express, SONET, Serial RapidIO, 1G Fibre Channel, 2G Fibre Channel

■ 2Gbps High Performance PURESPEED™ I/O

- Supports the following performance bandwidths
 - Differential I/O up to 2Gbps DDR (1GHz Clock)
 - Single-ended memory interfaces up to 800Mbps
- 144 Tap programmable Input Delay (INDEL) block on every I/O dynamically aligns data to clock for robust performance
 - Dynamic bit Adaptive Input Logic (AIL) monitoring and control circuitry per pin that automatically ensures proper set-up and hold
 - Dynamic bus: uses control bus from DLL
 - Static per bit
- Electrical standards supported:
 - LVCMOS 3.3/2.5/1.8/1.5/1.2, LVTTTL
 - SSTL 3/2/18 I, II; HSTL 18/15 I, II
 - PCI, PCI-X
 - LVDS, Mini-LVDS, Bus-LVDS, MLVDS, LVPECL, RSDS
- Programmable On Die Termination (ODT)
 - Includes Thevenin Equivalent and low power V_{TT} termination options

■ Memory Intensive FPGA

- sysMEM™ embedded Block RAM

- 1 to 7.8 Mbits memory
- True Dual Port/Pseudo Dual Port/Single Port
- Dedicated FIFO logic for all block RAM
- 500MHz performance
- Additional 240K to 1.8Mbits distributed RAM

■ sysCLOCK™ Network

- Eight analog PLLs per device
 - Frequency range from 15MHz to 1GHz
 - Spread spectrum support
- 12 DLLs per device with direct control of I/O delay
 - Frequency range from 100MHz to 700MHz
- Extensive clocking network
 - 700MHz primary and 325 MHz secondary clocks
 - 1GHz I/O-connected edge clocks
- Precision Clock Divider
 - Phase matched x2 and x4 division of incoming clocks
- Dynamic Clock Select (DCS)
 - Glitch free clock MUX

■ Masked Array for Cost Optimization (MACO™) Blocks

- On-chip structured ASIC Blocks provide pre-engineered IP for low power, low cost system level integration

■ High Performance System Bus

- Ties FPGA elements together with a standard bus framework
 - Connects to peripheral user interfaces for run-time dynamic configuration

■ System Level Support

- IEEE standard 1149.1 Boundary Scan, plus ispTRACY™ internal logic analyzer
- IEEE Standard 1532 in-system configuration
- 1.2V and 1.0V operation
- Onboard oscillator for initialization and general use
- Embedded PowerPC microprocessor interface
- Low cost wire-bond and high pin count flip-chip packaging
- Low cost SPI Flash RAM configuration

Table 1-1. LatticeSC Family Selection Guide¹

Device	SC15	SC25	SC40	SC80	SC115
LUT4s (K)	15	25	40	80	115
sysMEM Blocks (18Kb)	56	104	216	308	424
Embedded Memory (Mbits)	1.03	1.92	3.98	5.68	7.8
Max. Distributed Memory (Mbits)	0.24	0.41	0.65	1.28	1.84
Number of 3.8Gbps SERDES (Max.)	8	16	16	32	32
DLLs	12	12	12	12	12
Analog PLLs	8	8	8	8	8
MACO Blocks	4	6	10	10	12
Package I/O/SERDES Combinations (1mm ball pitch)					
256-ball fpBGA (17 x 17mm)	139/4				
900-ball fpBGA (31 x 31mm)	300/8	378/8			
1020-ball fcBGA (33 x 33mm) ²		476/16	562/16		
1152-ball fcBGA (35 x 35mm) ³			604/16	660/16	660/16
1704-ball fcBGA (42.5 x 42.5mm) ³				904/32	942/32

1. The information in this preliminary data sheet is by definition not final and subject to change. Please consult the Lattice web site and your local Lattice sales office to ensure you have the latest information regarding the specifications for these products as you make critical design decisions.
2. Organic fcBGA converted to organic fcBGA revision 2 per [PCN #02A-10](#).
3. Ceramic fcBGA converted to organic fcBGA per [PCN #01A-10](#).

The LatticeSCM devices add MACO-enabled IP functionality to the base LatticeSC devices. Table 1-2 shows the type and number of each pre-engineered IP core.

Table 1-2. LatticeSCM Family

Device	SCM15	SCM25	SCM40	SCM80	SCM115
flexiMAC Blocks • 1GbE Mode • 10GbE Mode • PCI Express Mode	1	2	2	2	4
SPI4.2 Blocks	1	2	2	2	2
Memory Controller Blocks • DDR/DDR2 DRAM Mode • QDR II/II+ SRAM Mode • RLDRAM I • RLDRAM II CIO/SIO	1	2	2	2	2
Low-Speed CDR Blocks	0	0	2	2	2
PCI Express LTSSM (PHY) Blocks	1	0	2	2	2

Note: See each IP core user's guide for more information about support for specific LatticeSCM devices.

Introduction

The LatticeSC family of FPGAs combines a high-performance FPGA fabric, high-speed SERDES, high-performance I/Os and large embedded RAM in a single industry leading architecture. This FPGA family is fabricated in a state of the art technology to provide one of the highest performing FPGAs in the industry.

This family of devices includes features to meet the needs of today's communication network systems. These features include SERDES with embedded advance PCS (Physical Coding sub-layer), up to 7.8 Mbits of sysMEM embedded block RAM, dedicated logic to support system level standards such as RAPIDIO, SPI4.2, SFI-4, UTOPIA, XGMII and CSIX. The devices in this family feature clock multiply, divide and phase shift PLLs, numerous

toggled. There are eight DCS blocks per device, located in pairs at the center of each side. Figure 2-9 illustrates the DCS Block diagram.

Figure 2-9. DCS Block Diagram

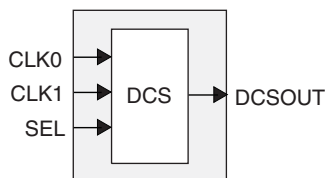
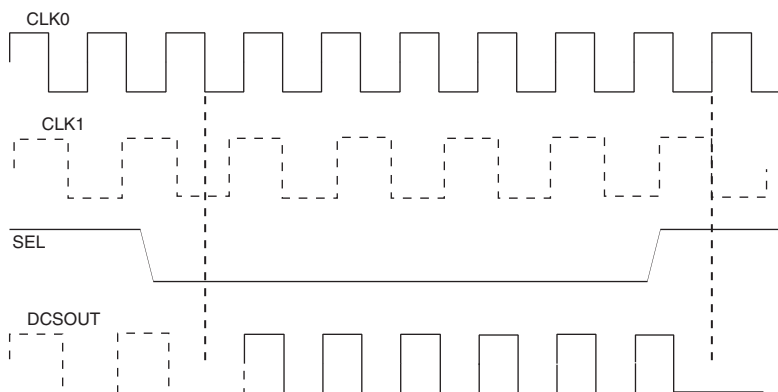


Figure 2-10 shows timing waveforms for one of the DCS operating modes. The DCS block can be programmed to other modes. For more information on the DCS, please see details of additional technical documentation at the end of this data sheet.

Figure 2-10. DCS Waveforms



Clock Boosting

There are programmable delays available in the clock signal paths in the PFU, PIC and EBR blocks. These allow setup and clock-to-output times to be traded to meet critical timing without slowing the system clock. If this feature is enabled then the design tool automatically uses these delays to improve timing performance.

Global Set/Reset

There is a global set/reset (GSR) network on the device that is distributed to all FFs, PLLs, DLLs and other blocks on the device. This GSR network can operate in two modes:

- asynchronous - no clock is required to get into or out of the reset state.
- synchronous - The global GSR net is synchronized to a user selected clock. In this mode it continues to be asynchronous to get into the reset state, but is synchronous to get out of the reset state. This allows all registers on the device to become operational in the same clock period. The synchronous GSR goes out of reset in two cycles from the clock edge where the setup time of the FF was met (not from the GSR being released).

sysCLOCK Phase Locked Loops (PLLs)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. Each PLL has four dividers associated with it: input clock divider, feedback divider and two clock output dividers. The input divider is used to divide the input clock signal, while the feedback divider is used to multiply the input clock signal.

Table 2-6. Input/Output/Tristate Gearing Resource Rules

PIO	Input/Output Logic			Tri-State/Bidi	
	x1	x2	x4	x1	x2/x4
A	?	?	?	?	N/A
B	?	No I/O Logic	No I/O Logic	?	N/A
C	?	?	No I/O Logic	?	N/A
D	?	No I/O Logic	No I/O Logic	?	N/A

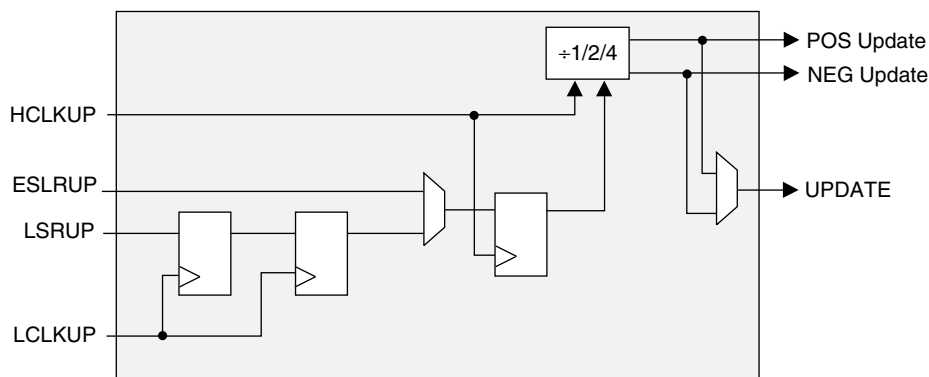
Note: Pin can still be used without I/O logic.

Control Logic Block

The control logic block allows the modification of control signals selected by the routing before they are used in the PIO. It can optionally invert all signals passing through it except the Global Set/Reset. Global Set/Reset can be enabled or disabled. It can route either the edge clock or the clock to the high-speed clock nets. The clock provided to the PIO by routing is used as the slow-speed clocks. In addition this block contains delays that can be inserted in the clock nets to enable Lattice's unique cycle boosting capability.

Update Block

The update block is used to generate the POS update and NEG update signals used by the DDR/Shift register blocks within the PIO. Note the update block is only required in shift modes. This is required in order to do the high speed to low speed handoff. One of these update signals is also selected and output from the PIC as the signal UPDATE. It consists of a shift chain that operates off either the high-speed input or output clock. The values of each register in the chain are set or reset depending on the desired mode of operation. The set/reset signal is generated from either the edge reset ELSR or the local reset LSR. These signals are optionally inverted by the Control Logic Block and provided to the update block as ELSRUP and LSRUP. The Lattice design tools automatically configure and connect the update block when one of the DDR or shift register primitives is used.

Figure 2-25. Update Block

PURESPEED I/O Buffer

Each I/O is associated with a flexible buffer referred to as PURESPEED I/O buffer. These buffers are arranged around the periphery of the device in seven groups referred to as Banks. The PURESPEED I/O buffers allow users to implement the wide variety of standards that are found in today's systems including LVCMOS, SSTL, HSTL, LVDS and LVPECL. The availability of programmable on-chip termination for both input and output use, further enhances the utility of these buffers.

3. Bottom Side (Banks 4 and 5)

These buffers can support LVCMOS standards up to 3.3V, including PCI33, PCI-X33 and SSTL-33. Differential receivers are provided on all PIO pairs but true HLVDS and RSDS differential drivers are not available. Adaptive input logic is available on PIOs A or C.

Table 2-8 lists the standards supported by each side.

Table 2-8. I/O Standards Supported by Different Banks

Description	Top Side Banks 1	Right Side Banks 2-3	Bottom Side Banks 4-5	Left Side Banks 6-7
I/O Buffer Type	Single-ended, Differential Receiver	Single-ended, Differen- tial Receiver and Driver	Single-ended, Differential Receiver	Single-ended, Differen- tial Receiver and Driver
Output Standards Supported	LVTTL LVCMOS33 LVCMOS25 LVCMOS18 LVCMOS15 LVCMOS12 SSTL18_I, II SSTL25_I, II SSTL33_I, II HSTL15_I, II, III ¹ , IV ¹ HSTL18_I, II, III ¹ , IV ¹ SSTL18D_I, II SSTL25D_I, II SSTL33D_I, II HSTL15D_I, II HSTL18D_I, II PCI33 PCIX15 PCIX33 AGP1X33 AGP2X33 MLVDS/BLVDS GTL ² , GTL+ ²	LVCMOS25 LVCMOS18 LVCMOS15 LVCMOS12 SSTL18_I, II SSTL25_I, II HSTL15_I, III HSTL18_I, II, III PCIX15 SSTL18D_I, II SSTL25D_I, II HSTL15D_I, II HSTL18D_I, II LVDS/RSDS Mini-LVDS MLVDS/BLVDS GTL ² , GTL+ ²	LVTTL LVCMOS33 LVCMOS25 LVCMOS18 LVCMOS15 LVCMOS12 SSTL18_I, II SSTL25_I, II SSTL33_I, II HSTL15_I, II, III ¹ , IV ¹ HSTL18_I, II, III ¹ , IV ¹ SSTL18D_I, II SSTL25D_I, II SSTL33D_I, II HSTL15D_I, II HSTL18D_I, II PCI33 PCIX15 PCIX33 AGP1X33 AGP2X33 MLVDS/BLVDS GTL ² , GTL+ ²	LVCMOS25 LVCMOS18 LVCMOS15 LVCMOS12 SSTL18_I, II SSTL25_I, II HSTL15_I, III HSTL18_I, II, III PCIX15 SSTL18D_I, II SSTL25D_I, II HSTL15D_I, II HSTL18D_I, II LVDS/RSDS Mini-LVDS MLVDS/BLVDS GTL ² , GTL+ ²
Input Standards Supported	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential
Clock Inputs	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential
Differential Output Support via Emulation	LVDS/MLVDS/BLVDS/ LVPECL	MLVDS/BLVDS/ LVPECL	LVDS/MLVDS/BLVDS/ LVPECL	MLVDS/BLVDS/ LVPECL
AIL Support	No	Yes	Yes	Yes

1. Input only.

2. Input only. Outputs supported by bussing multiple outputs together.

Supported Standards

The LatticeSC PURESPEED I/O buffer supports both single-ended and differential standards. Single-ended standards can be further subdivided into LVCMOS, LVTTL and other standards. The buffers support the LVTTL, LVCMOS 12, 15, 18, 25 and 33 standards. In the LVCMOS and LVTTL modes, the buffer has individually configurable options for drive strength, termination resistance, bus maintenance (weak pull-up, weak pull-down, or a bus-keeper latch) and open drain. Other single-ended standards supported include SSTL, HSTL, GTL (input only), GTL+ (input only), PCI33, PCIX33, PCIX15, AGP-1X33 and AGP-2X33. Differential standards supported include LVDS, RSDS, BLVDS, MLVDS, LVPECL, differential SSTL and differential HSTL. Tables 12 and 13 show the I/O standards (together with their supply and reference voltages) supported by the LatticeSC devices. The tables also provide the available internal termination schemes. For further information on utilizing the PURESPEED I/O buffer to support a variety of standards please see details of additional technical documentation at the end of this data sheet.

Power Supply Ramp Rates

Symbol	Parameter	Condition	Min.	Typ.	Max	Units
t_{RAMP}	Power supply ramp rates for all power supplies	Over process, voltage, temperature	3.45	—	—	mV/ μ s
			—	—	75	ms

1. See the Power-up and Power-Down requirements section for more details on power sequencing.
2. From 0.5V to minimum operating voltage.

Hot Socketing Specifications¹

Symbol	Parameter	Condition	Min.	Typ.	Max	Units
I_{DK}	Programmable and dedicated Input or I/O leakage current ^{2, 3, 4, 5, 6}	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	—	—	± 1500	μ A
I_{HDIN}	SERDES average input current when device powered down and inputs driven ⁷		—	—	4	mA

1. See Hot Socket power up/down information in Chapter 2 of this document.
2. Assumes monotonic rise/fall rates for all power supplies.
3. Sensitive to power supply sequencing as described in hot socketing section.
4. Assumes power supplies are between 0 and maximum recommended operations conditions.
5. I_{DK} is additive to I_{PU} , I_{PD} or I_{BH} .
6. Represents DC conditions. For the first 20ns after hot insertion, current specification is 8 mA.
7. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed VDDOB of 1.575V, 8b/10b data and internal AC coupling.

DC Electrical Characteristics⁵

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min. ³	Typ.	Max.	Units
$I_{\text{IL}}, I_{\text{IH}}^1$	Input or I/O Low leakage	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	—	—	10	μ A
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{\text{IN}} \leq 0.7 V_{\text{CCIO}}$	-30	—	-210	μ A
I_{PD}	I/O Active Pull-down Current	$V_{\text{IL}} (\text{MAX}) \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	30	—	210	μ A
I_{BHLS}	Bus Hold Low Sustaining Current	$V_{\text{IN}} = V_{\text{IL}} (\text{MAX})$	30	—	—	μ A
I_{BHHS}	Bus Hold High Sustaining Current	$V_{\text{IN}} = 0.7 V_{\text{CCIO}}$	-30	—	—	μ A
I_{BHLO}	Bus Hold Low Overdrive Current	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	—	—	210	μ A
I_{BHLH}	Bus Hold High Overdrive Current	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	—	—	-210	μ A
I_{CL}	PCI Low Clamp Current	$-3 < V_{\text{IN}} \leq -1$	$-25 + (V_{\text{IN}} + 1)/0.015$	—	—	mA
I_{CH}	PCI High Clamp Current	$V_{\text{CC}} + 4 > V_{\text{IN}} \geq V_{\text{CC}} + 1$	$25 + (V_{\text{IN}} - V_{\text{CC}} - 1)/0.015$	—	—	mA
V_{BHT}	Bus Hold trip Points	$0 \leq V_{\text{IN}} \leq V_{\text{IH}} (\text{MAX})$	$V_{\text{IL}} (\text{MAX})$	—	$V_{\text{IH}} (\text{MIN})$	V
C1	I/O Capacitance ²	$V_{\text{CCIO}} = 3.3\text{V}, 2.5\text{V}, 1.8\text{V}, 1.5\text{V}, 1.2\text{V},$ $V_{\text{CC}} = 1.2\text{V}, V_{\text{CCIP2}} = 1.2\text{V},$ $V_{\text{CCAUX}} = 2.5, V_{\text{IO}} = 0 \text{ to } V_{\text{IH}} (\text{MAX})$	—	8	—	pf
C3 ²	Dedicated Input Capacitance ²	$V_{\text{CCIO}} = 3.3\text{V}, 2.5\text{V}, 1.8\text{V}, 1.5\text{V}, 1.2\text{V},$ $V_{\text{CC}} = 1.2\text{V}, V_{\text{CCIP2}} = 1.2\text{V},$ $V_{\text{CCAUX}} = 2.5, V_{\text{IO}} = 0 \text{ to } V_{\text{IH}} (\text{MAX})$	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.
2. $T_{\text{A}} = 25^{\circ}\text{C}$, $f = 1.0\text{MHz}$
3. I_{PU} , I_{PD} , I_{BHLS} and I_{BHHS} have minimum values of 15 or -15 μ A if V_{CCIO} is set to 1.2V nominal.
4. This table does not apply to SERDES pins.
5. For programmable I/Os.

Initialization and Standby Supply Current

The table below indicates initialization and standby supply current while operating at 85°C junction temperature (T_J), which is the high end of the commercial temperature range, and 105°C, which is the high end of the industrial temperature range. This data assumes all outputs are tri-stated and all inputs are configured as LVCMOS and held at V_{CCIO} or GND. The remaining SERDES supply current for V_{DDIB} and V_{DDOB} is detailed in the SERDES section of this data sheet. For power at your design temperature, it is recommended to use the Power Calculator tool which is accessible in ispLEVER or can be used as a standalone tool. For more information on supply current, see the reference to additional technical documentation available at the end of this data sheet.

Over Recommended Operating Conditions

Symbol	Condition	Parameter	Device	25°C Typ. ¹	85°C Max. ²		105°C Max. ²	Units
				All	-5, -6	-7	-5, -6	
I_{CC}	(VCC = 1.2V +/- 5%)	Core Operating Power Supply Current	LFSC/M15	65	449	678	755	mA
			LFSC/M25	113	798	1255	1343	mA
			LFSC/M40	159	1178	2006	1981	mA
			LFSC/M80	276	2122	3827	3569	mA
			LFSC/M115	454	3376	—	5679	mA
	(VCC = 1.0V +/- 5%)	Core Operating Power Supply Current	LFSC/M15	45	312	471	524	mA
			LFSC/M25	79	554	872	933	mA
			LFSC/M40	110	818	1393	1375	mA
			LFSC/M80	191	1473	2658	2478	mA
			LFSC/M115	315	2344	—	3943	mA
I_{CC12}		1.2V Power Supply Current for Configuration Logic, FPGA PLL, SERDES PLL and SERDES Analog Supplies	LFSC/M15	23	39	59	35	mA
			LFSC/M25	25	50	78	56	mA
			LFSC/M40	31	78	133	89	mA
			LFSC/M80	50	108	195	123	mA
			LFSC/M115	65	131	—	154	mA
I_{CCAUX}		Auxiliary Operating Power Supply Current	LFSC/M15	7	12	19	14	mA
			LFSC/M25	9	16	25	18	mA
			LFSC/M40	12	23	39	25	mA
			LFSC/M80	13	25	45	23	mA
			LFSC/M115	16	27	—	26	mA
I_{CCIO} and I_{CCJ}		Bank Power Supply Current (per bank)	LFSC/M15	0.1	0.2	0.3	0.2	mA
			LFSC/M25	0.3	0.6	1.0	0.7	mA
			LFSC/M40	0.4	0.9	1.5	1.0	mA
			LFSC/M80	0.5	1.1	2.1	1.3	mA
			LFSC/M115	0.7	1.5	—	1.8	mA

1. I_{CC} is specified at $T_J = 25^\circ\text{C}$ and typical V_{CC} .

2. I_{CC} is specified at the respective commercial and industrial maximum T_J and V_{CC} limits.

Switching Characteristics

All devices are 100% functionally tested. Listed below are representative values of internal and external timing parameters. For more specific, more precise, and worst-case guaranteed data at a particular temperature and voltage, use the values reported by the static timing analyzer in the ispLEVER design tool from Lattice and back-annotate to the simulation net list.

LatticeSC/M Family Timing Adders

Over Recommended Operating Conditions at VCC = 1.2V +/- 5%

Buffer Type	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Input Adjusters								
LVDS	LVDS	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
RSDS	RSDS	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
BLVDS25	BLVDS	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
MLVDS25	MLVDS	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
LVPECL33	LVPECL	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
HSTL18_I	HSTL_18 class I	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
HSTL18_II	HSTL_18 class II	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
HSTL18_III	HSTL_18 class III	-0.016	-0.018	0.008	0.003	0.032	0.023	ns
HSTL18_IV	HSTL_18 class IV	-0.016	-0.018	0.008	0.003	0.032	0.023	ns
HSTL18D_I	Differential HSTL 18 class I	0.006	0.001	0.029	0.024	0.052	0.046	ns
HSTL18D_II	Differential HSTL 18 class II	0.006	0.001	0.029	0.024	0.052	0.046	ns
HSTL15_I	HSTL_15 class I	-0.005	-0.016	0.026	-0.001	0.057	0.014	ns
HSTL15_II	HSTL_15 class II	-0.005	-0.016	0.026	-0.001	0.057	0.014	ns
HSTL15_III	HSTL_15 class III	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
HSTL15_IV	HSTL_15 class IV	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
HSTL15D_I	Differential HSTL 15 class I	-0.021	-0.022	0.001	-0.009	0.022	0.003	ns
HSTL15D_II	Differential HSTL 15 class II	-0.021	-0.022	0.001	-0.009	0.022	0.003	ns
SSTL33_I	SSTL_3 class I	-0.036	-0.061	-0.181	-0.313	-0.326	-0.565	ns
SSTL33_II	SSTL_3 class II	-0.036	-0.061	-0.181	-0.313	-0.326	-0.565	ns
SSTL33D_I	Differential SSTL_3 class I	0.012	0.012	0.034	0.028	0.055	0.043	ns
SSTL33D_II	Differential SSTL_3 class II	0.012	0.012	0.034	0.028	0.055	0.043	ns
SSTL25_I	SSTL_2 class I	0.003	-0.008	0.03	0.011	0.058	0.03	ns
SSTL25_II	SSTL_2 class II	0.003	-0.008	0.03	0.011	0.058	0.03	ns
SSTL25D_I	Differential SSTL_2 class I	0.006	0	0.031	0.023	0.056	0.046	ns
SSTL25D_II	Differential SSTL_2 class II	0.006	0	0.031	0.023	0.056	0.046	ns
SSTL18_I	SSTL_18 class I	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
SSTL18_II	SSTL_18 class II	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
SSTL18D_I	Differential SSTL_18 class I	0.006	0.001	0.029	0.024	0.052	0.046	ns
SSTL18D_II	Differential SSTL_18 class II	0.006	0.001	0.029	0.024	0.052	0.046	ns
LVTTTL33	LVTTTL	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
LVC MOS33	LVC MOS 3.3	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
LVC MOS25	LVC MOS 2.5	0	0	0	0	0	0	ns
LVC MOS18	LVC MOS 1.8	-0.068	-0.068	-0.087	-0.087	-0.105	-0.105	ns
LVC MOS15	LVC MOS 1.5	-0.131	-0.131	-0.186	-0.186	-0.241	-0.241	ns
LVC MOS12	LVC MOS 1.2	-0.238	-0.238	-0.364	-0.364	-0.49	-0.49	ns
PCI33	PCI	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
PCIX33	PCI-X 3.3	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
PCIX15	PCI-X 1.5	-0.005	-0.016	0.026	-0.001	0.057	0.014	ns
AGP1X33	AGP-1X 3.3	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
AGP2X33	AGP-2X	-0.036	-0.061	-0.181	-0.313	-0.326	-0.565	ns

LFSC/M15 Logic Signal Connections: 256 fpBGA^{1,2}

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
E4	A_VDDAX25_L	-	
B1	A_REFCLKP_L	-	
C1	A_REFCLKN_L	-	
D2	RESP_ULC	-	
F5	RESETN	1	
D1	DONE	1	
E1	INITN	1	
E2	M0	1	
E3	M1	1	
E5	M2	1	
E6	M3	1	
F2	PL15A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
F1	PL15B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
F3	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
G1	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
G4	PL18D	7	VREF2_7
H3	PL22A	7	
H2	PL22B	7	
H5	PL22C	7	VREF1_7
G5	PL22D	7	DIFFR_7
H1	PL23A	7	PCLKT7_1
J1	PL23B	7	PCLKC7_1
J2	PL24A	7	PCLKT7_0
J3	PL24B	7	PCLKC7_0
H4	PL24C	7	PCLKT7_2
H6	PL24D	7	PCLKC7_2
J4	PL26A	6	PCLKT6_0
K5	PL26B	6	PCLKC6_0
J5	PL26C	6	PCLKT6_1
J6	PL26D	6	PCLKC6_1
K1	PL28A	6	
L1	PL28B	6	
L4	PL28C	6	PCLKT6_2
K4	PL28D	6	PCLKC6_2
L2	PL31C	6	VREF1_6
L3	PL35A	6	
M3	PL35B	6	
M2	PL35D	6	DIFFR_6
M1	PL37A	6	
N1	PL37B	6	
P2	PL41D	6	VREF2_6
M5	PL43A	6	

LFSC/M15 Logic Signal Connections: 256 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
C5	A_VDDIB1_L	-	
A5	A_HDINP1_L	-	PCS 360 CH 1 IN P
B5	A_HDINN1_L	-	PCS 360 CH 1 IN N
A4	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
B4	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C4	A_VDDOB1_L	-	
B3	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
C3	A_VDDOB0_L	-	
A3	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
B2	A_HDINN0_L	-	PCS 360 CH 0 IN N
A2	A_HDINP0_L	-	PCS 360 CH 0 IN P
C2	A_VDDIB0_L	-	
A1	GND	-	
A16	GND	-	
B10	GND	-	
C13	GND	-	
D15	GND	-	
D3	GND	-	
E11	GND	-	
F13	GND	-	
G14	GND	-	
G2	GND	-	
G8	GND	-	
H10	GND	-	
J7	GND	-	
K15	GND	-	
K3	GND	-	
K9	GND	-	
M6	GND	-	
N11	GND	-	
N14	GND	-	
N2	GND	-	
P10	GND	-	
P4	GND	-	
R13	GND	-	
R7	GND	-	
G10	VCC	-	
G7	VCC	-	
G9	VCC	-	
H7	VCC	-	
H8	VCC	-	
H9	VCC	-	
J10	VCC	-	
J8	VCC	-	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
U18	GND	-		GND	-	
U19	GND	-		GND	-	
U20	GND	-		GND	-	
V11	GND	-		GND	-	
V12	GND	-		GND	-	
V13	GND	-		GND	-	
V14	GND	-		GND	-	
V15	GND	-		GND	-	
V16	GND	-		GND	-	
V17	GND	-		GND	-	
V18	GND	-		GND	-	
V19	GND	-		GND	-	
V20	GND	-		GND	-	
W11	GND	-		GND	-	
W12	GND	-		GND	-	
W13	GND	-		GND	-	
W14	GND	-		GND	-	
W15	GND	-		GND	-	
W16	GND	-		GND	-	
W17	GND	-		GND	-	
W18	GND	-		GND	-	
W19	GND	-		GND	-	
W20	GND	-		GND	-	
Y11	GND	-		GND	-	
Y12	GND	-		GND	-	
Y13	GND	-		GND	-	
Y14	GND	-		GND	-	
Y15	GND	-		GND	-	
Y16	GND	-		GND	-	
Y17	GND	-		GND	-	
Y18	GND	-		GND	-	
Y19	GND	-		GND	-	
Y20	GND	-		GND	-	
H2	VCCIO7	-		VCCIO7	-	
N4	VCCIO7	-		VCCIO7	-	
N6	VCCIO7	-		VCCIO7	-	
J2	VCCIO7	-		VCCIO7	-	
L2	VCCIO7	-		VCCIO7	-	
H4	VCCIO7	-		VCCIO7	-	
AB2	VCCIO6	-		VCCIO6	-	
AD1	VCCIO6	-		VCCIO6	-	
W4	VCCIO6	-		VCCIO6	-	
AA4	VCCIO6	-		VCCIO6	-	
AE7	VCCIO5	-		VCCIO5	-	
AH6	VCCIO5	-		VCCIO5	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F19	PT24A	1	MPI_TEA	PT30A	1	MPI_TEA
J18	PT23D	1	D14/MPI_DATA14	PT28D	1	D14/MPI_DATA14
K18	PT23C	1	DP1/MPI_PAR1	PT28C	1	DP1/MPI_PAR1
E20	PT23B	1	A21/MPI_BURST	PT27B	1	A21/MPI_BURST
F20	PT23A	1	D15/MPI_DATA15	PT27A	1	D15/MPI_DATA15
C23	B_REFCLKP_L	-		B_REFCLKP_L	-	
D23	B_REFCLKN_L	-		B_REFCLKN_L	-	
B23	VCC12	-		VCC12	-	
H21	B_VDDIB3_L	-		B_VDDIB3_L	-	
F21	B_HDINP3_L	-	PCS 361 CH 3 IN P	B_HDINP3_L	-	PCS 361 CH 3 IN P
G21	B_HDINN3_L	-	PCS 361 CH 3 IN N	B_HDINN3_L	-	PCS 361 CH 3 IN N
A21	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P
B21	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N
D21	B_VDDOB3_L	-		B_VDDOB3_L	-	
B22	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N
D22	B_VDDOB2_L	-		B_VDDOB2_L	-	
A22	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P
G22	B_HDINN2_L	-	PCS 361 CH 2 IN N	B_HDINN2_L	-	PCS 361 CH 2 IN N
F22	B_HDINP2_L	-	PCS 361 CH 2 IN P	B_HDINP2_L	-	PCS 361 CH 2 IN P
H22	B_VDDIB2_L	-		B_VDDIB2_L	-	
H24	B_VDDIB1_L	-		B_VDDIB1_L	-	
G23	B_HDINP1_L	-	PCS 361 CH 1 IN P	B_HDINP1_L	-	PCS 361 CH 1 IN P
H23	B_HDINN1_L	-	PCS 361 CH 1 IN N	B_HDINN1_L	-	PCS 361 CH 1 IN N
A24	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
B24	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-		B_VDDOB1_L	-	
B25	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-		B_VDDOB0_L	-	
A25	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
G25	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
F25	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
H25	B_VDDIB0_L	-		B_VDDIB0_L	-	
H26	A_VDDIB3_L	-		A_VDDIB3_L	-	
F26	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
G26	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A26	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
B26	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
D26	A_VDDOB3_L	-		A_VDDOB3_L	-	
B27	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
D27	A_VDDOB2_L	-		A_VDDOB2_L	-	
A27	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
G27	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
F27	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
H27	A_VDDIB2_L	-		A_VDDIB2_L	-	
F29	A_VDDIB1_L	-		A_VDDIB1_L	-	
G28	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
H28	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A29	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
B29	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
D29	A_VDDOB1_L	-		A_VDDOB1_L	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
G27	A_REFCLKP_L	-		A_REFCLKP_L	-	
H27	A_REFCLKN_L	-		A_REFCLKN_L	-	
H25	VCC12	-		VCC12	-	
H26	RESP_ULC	-		RESP_ULC	-	
B33	RESETN	1		RESETN	1	
C34	TSALLN	1		TSALLN	1	
D34	DONE	1		DONE	1	
C33	INITN	1		INITN	1	
J27	M0	1		M0	1	
K27	M1	1		M1	1	
M26	M2	1		M2	1	
L26	M3	1		M3	1	
F30	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
G30	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
H28	PL16C	7		PL16C	7	
J28	PL16D	7		PL16D	7	
F31	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
G31	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
N25	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A
P25	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A
D33	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C
E33	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C
H29	PL18C	7		PL18C	7	
J29	PL18D	7	VREF2_7	PL18D	7	VREF2_7
F32	PL21A	7		PL20A	7	
G32	PL21B	7		PL20B	7	
P26	PL21C	7		PL20C	7	
N26	PL21D	7		PL20D	7	
H30	PL22A	7		PL21A	7	
J30	PL22B	7		PL21B	7	
L28	PL22C	7		PL21C	7	
M28	PL22D	7		PL21D	7	
J31	PL23A	7		PL29A	7	
K31	PL23B	7		PL29B	7	
L27	PL23C	7	VREF1_7	PL29C	7	VREF1_7
M27	PL23D	7	DIFFR_7	PL29D	7	DIFFR_7
J32	PL25A	7		PL31A	7	
K32	PL25B	7		PL31B	7	
L29	PL25C	7		PL31C	7	
M29	PL25D	7		PL31D	7	
H33	PL26A	7		PL33A	7	
J33	PL26B	7		PL33B	7	
N27	PL26C	7		PL33C	7	
P27	PL26D	7		PL33D	7	
K33	PL27A	7		PL35A	7	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E24	B_HDINP1_L	-	PCS 361 CH 1 IN P	B_HDINP1_L	-	PCS 361 CH 1 IN P
F24	B_HDINN1_L	-	PCS 361 CH 1 IN N	B_HDINN1_L	-	PCS 361 CH 1 IN N
A23	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
L25	VCC12	-		VCC12	-	
B23	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-		B_VDDOB1_L	-	
B24	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-		B_VDDOB0_L	-	
A24	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
K25	VCC12	-		VCC12	-	
F25	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
E25	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
D28	B_VDDIB0_L	-		B_VDDIB0_L	-	
G25	VCC12	-		VCC12	-	
D29	A_VDDIB3_L	-		A_VDDIB3_L	-	
C25	VCC12	-		VCC12	-	
A25	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B25	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A26	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
E27	VCC12	-		VCC12	-	
B26	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
F26	A_VDDOB3_L	-		A_VDDOB3_L	-	
B27	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
F27	A_VDDOB2_L	-		A_VDDOB2_L	-	
A27	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E28	VCC12	-		VCC12	-	
B28	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
A28	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
D30	A_VDDIB2_L	-		A_VDDIB2_L	-	
C28	VCC12	-		VCC12	-	
D31	A_VDDIB1_L	-		A_VDDIB1_L	-	
C29	VCC12	-		VCC12	-	
A29	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B29	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A30	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
E29	VCC12	-		VCC12	-	
B30	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
F28	A_VDDOB1_L	-		A_VDDOB1_L	-	
B31	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
F29	A_VDDOB0_L	-		A_VDDOB0_L	-	
A31	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E30	VCC12	-		VCC12	-	
B32	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
A32	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
D32	A_VDDIB0_L	-		A_VDDIB0_L	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
R7	NC	-		PR39D	2	
P7	NC	-		PR39C	2	
N3	NC	-		PR39B	2	
M3	NC	-		PR39A	2	
H1	NC	-		PR26B	2	
G1	NC	-		PR26A	2	
L5	NC	-		PR25B	2	
K5	NC	-		PR25A	2	
G2	NC	-		PR24B	2	
F2	NC	-		PR24A	2	
F1	NC	-		PR22B	2	
E1	NC	-		PR22A	2	
A2	GND	-		GND	-	
A33	GND	-		GND	-	
AA15	GND	-		GND	-	
AA20	GND	-		GND	-	
AA32	GND	-		GND	-	
AA4	GND	-		GND	-	
AB28	GND	-		GND	-	
AB6	GND	-		GND	-	
AC11	GND	-		GND	-	
AC18	GND	-		GND	-	
AC25	GND	-		GND	-	
AD23	GND	-		GND	-	
AD3	GND	-		GND	-	
AD31	GND	-		GND	-	
AE12	GND	-		GND	-	
AE15	GND	-		GND	-	
AE29	GND	-		GND	-	
AE7	GND	-		GND	-	
AE9	GND	-		GND	-	
AF20	GND	-		GND	-	
AF26	GND	-		GND	-	
AG32	GND	-		GND	-	
AG4	GND	-		GND	-	
AH13	GND	-		GND	-	
AH19	GND	-		GND	-	
AH25	GND	-		GND	-	
AH7	GND	-		GND	-	
AJ10	GND	-		GND	-	
AJ16	GND	-		GND	-	
AJ22	GND	-		GND	-	
AJ28	GND	-		GND	-	
AK3	GND	-		GND	-	
AK31	GND	-		GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P38	PL26B	7		PL40B	7	
N35	PL26C	7		PL40C	7	
N36	PL26D	7		PL40D	7	
N39	PL29A	7		PL43A	7	
P39	PL29B	7		PL43B	7	
R34	PL29C	7	VREF1_7	PL43C	7	VREF1_7
T34	PL29D	7	DIFFR_7	PL43D	7	DIFFR_7
L41	PL30A	7		PL44A	7	
M41	PL30B	7		PL44B	7	
W29	PL30C	7		PL44C	7	
Y29	PL30D	7		PL44D	7	
L42	PL31A	7		PL45A	7	
M42	PL31B	7		PL45B	7	
U32	PL31C	7		PL45C	7	
V32	PL31D	7		PL45D	7	
R37	PL33A	7		PL47A	7	
T37	PL33B	7		PL47B	7	
M36	PL33C	7		PL47C	7	
M37	PL33D	7		PL47D	7	
P40	PL34A	7		PL48A	7	
N40	PL34B	7		PL48B	7	
R35	PL34C	7		PL48C	7	
T35	PL34D	7		PL48D	7	
N41	PL35A	7		PL49A	7	
P41	PL35B	7		PL49B	7	
V33	PL35C	7		PL49C	7	
U33	PL35D	7		PL49D	7	
R38	PL37A	7		PL51A	7	
T38	PL37B	7		PL51B	7	
R36	PL37C	7		PL51C	7	
T36	PL37D	7		PL51D	7	
N42	PL38A	7		PL52A	7	
P42	PL38B	7		PL52B	7	
Y31	PL38C	7		PL52C	7	
AA31	PL38D	7		PL52D	7	
U37	PL39A	7		PL53A	7	
V37	PL39B	7		PL53B	7	
U34	PL39C	7		PL53C	7	
V34	PL39D	7		PL53D	7	
U39	PL41A	7		PL55A	7	
T39	PL41B	7		PL55B	7	
V35	PL41C	7		PL55C	7	
W35	PL41D	7		PL55D	7	
R41	PL42A	7		PL56A	7	
T41	PL42B	7		PL56B	7	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCI/O Bank	Dual Function	Ball Function	VCCI/O Bank	Dual Function
AY41	PB12A	5		PB13A	5	
BA41	PB12B	5		PB13B	5	
AT39	PB12C	5		PB13C	5	
AT38	PB12D	5		PB13D	5	
AV37	PB13A	5		PB15A	5	
AV36	PB13B	5		PB15B	5	
AM31	PB13C	5		PB15C	5	
AM32	PB13D	5		PB15D	5	
BA40	PB15A	5		PB16A	5	
BB40	PB15B	5		PB16B	5	
AM29	PB15C	5		PB16C	5	
AL29	PB15D	5		PB16D	5	
AY39	PB16A	5		PB17A	5	
AY38	PB16B	5		PB17B	5	
AN33	PB16C	5		PB17C	5	
AN32	PB16D	5		PB17D	5	
BA39	PB17A	5		PB19A	5	
BA38	PB17B	5		PB19B	5	
AT37	PB17C	5		PB19C	5	
AT36	PB17D	5		PB19D	5	
AW36	PB19A	5		PB20A	5	
AW35	PB19B	5		PB20B	5	
AM28	PB19C	5		PB20C	5	
AL28	PB19D	5		PB20D	5	
BB38	PB20A	5		PB21A	5	
BB39	PB20B	5		PB21B	5	
AR34	PB20C	5		PB21C	5	
AR33	PB20D	5		PB21D	5	
AV35	PB21A	5		PB23A	5	
AV34	PB21B	5		PB23B	5	
AT33	PB21C	5		PB23C	5	
AT34	PB21D	5		PB23D	5	
BA37	PB23A	5		PB25A	5	
BA36	PB23B	5		PB25B	5	
AP33	PB23C	5		PB25C	5	
AP32	PB23D	5		PB25D	5	
AY36	PB24A	5		PB26A	5	
AY35	PB24B	5		PB26B	5	
AN31	PB24C	5		PB26C	5	
AN30	PB24D	5		PB26D	5	
BB37	PB25A	5		PB27A	5	
BB36	PB25B	5		PB27B	5	
AP31	PB25C	5		PB27C	5	
AP30	PB25D	5		PB27D	5	
AV33	PB27A	5		PB29A	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AU9	PB103C	4		PB117C	4	
AU8	PB103D	4		PB117D	4	
AY8	PB104A	4		PB118A	4	
AY7	PB104B	4		PB118B	4	
AU7	PB104C	4		PB118C	4	
AU6	PB104D	4		PB118D	4	
BA7	PB105A	4		PB119A	4	
BA6	PB105B	4		PB119B	4	
AN13	PB105C	4		PB119C	4	
AN12	PB105D	4		PB119D	4	
AV9	PB107A	4		PB121A	4	
AV8	PB107B	4		PB121B	4	
AT10	PB107C	4		PB121C	4	
AT9	PB107D	4		PB121D	4	
AW8	PB108A	4		PB122A	4	
AW7	PB108B	4		PB122B	4	
AP11	PB108C	4		PB122C	4	
AP10	PB108D	4		PB122D	4	
BB5	PB109A	4		PB123A	4	
BB4	PB109B	4		PB123B	4	
AR10	PB109C	4		PB123C	4	
AR9	PB109D	4		PB123D	4	
BA5	PB111A	4		PB125A	4	
BA4	PB111B	4		PB125B	4	
AT7	PB111C	4		PB125C	4	
AT6	PB111D	4		PB125D	4	
BB3	PB112A	4		PB126A	4	
BA3	PB112B	4		PB126B	4	
AM14	PB112C	4		PB126C	4	
AL14	PB112D	4		PB126D	4	
AY5	PB113A	4		PB127A	4	
AY4	PB113B	4		PB127B	4	
AN11	PB113C	4		PB127C	4	
AN10	PB113D	4		PB127D	4	
AV7	PB115A	4		PB129A	4	
AV6	PB115B	4		PB129B	4	
AM12	PB115C	4		PB129C	4	
AM11	PB115D	4		PB129D	4	
AW5	PB116A	4		PB130A	4	
AW4	PB116B	4		PB130B	4	
AT5	PB116C	4		PB130C	4	
AT4	PB116D	4		PB130D	4	
AY2	PB117A	4		PB131A	4	
BA2	PB117B	4		PB131B	4	
AP9	PB117C	4		PB131C	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AC24	GND	-		GND	-	
AC26	GND	-		GND	-	
AC35	GND	-		GND	-	
AC8	GND	-		GND	-	
AD12	GND	-		GND	-	
AD16	GND	-		GND	-	
AD18	GND	-		GND	-	
AD20	GND	-		GND	-	
AD23	GND	-		GND	-	
AD25	GND	-		GND	-	
AD27	GND	-		GND	-	
AD31	GND	-		GND	-	
AE17	GND	-		GND	-	
AE19	GND	-		GND	-	
AE24	GND	-		GND	-	
AE26	GND	-		GND	-	
AE3	GND	-		GND	-	
AE39	GND	-		GND	-	
AF18	GND	-		GND	-	
AF20	GND	-		GND	-	
AF23	GND	-		GND	-	
AF25	GND	-		GND	-	
AF36	GND	-		GND	-	
AF7	GND	-		GND	-	
AG11	GND	-		GND	-	
AG16	GND	-		GND	-	
AG19	GND	-		GND	-	
AG24	GND	-		GND	-	
AG27	GND	-		GND	-	
AG32	GND	-		GND	-	
AH15	GND	-		GND	-	
AH28	GND	-		GND	-	
AH4	GND	-		GND	-	
AH40	GND	-		GND	-	
AJ35	GND	-		GND	-	
AJ8	GND	-		GND	-	
AK12	GND	-		GND	-	
AK31	GND	-		GND	-	
AL13	GND	-		GND	-	
AL19	GND	-		GND	-	
AL24	GND	-		GND	-	
AL3	GND	-		GND	-	
AL30	GND	-		GND	-	
AL39	GND	-		GND	-	
AM16	GND	-		GND	-	